SN74LV4040A-EP 12 BIT ASYNCHRONOUS BINARY COUNTERS

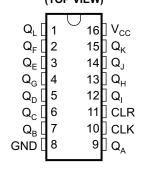
SGDS030-SEPTEMBER 2007

FEATURES

- Controlled Baseline
 - One Assembly
 - Test Site
 - One Fabrication Site
- Extended Temperature Performance of -55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- 2-V to 5.5-V V_{CC} Operation
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2.3 V at V_{CC} = 3.3 V, T_A = 25°C
- Support Mixed-Mode Voltage Operation on All Ports
- High On-Off Output-Voltage Ratio
- Low Crosstalk Between Switches
- Individual Switch Controls
- Extremely Low Input Current
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

SN74LV4040A . . . PW PACKAGE (TOP VIEW)



DESCRIPTION/ORDERING INFORMATION

The SN74LV4040A device is a 12 bit asynchronous binary counter with the outputs of all stages available externally. A high level at the clear (CLR) input asynchronously clears the counter and resets all outputs low. The count is advanced on a high-to-low transition at the clock (CLK) input. Applications include time-delay circuits, counter controls, and frequency-dividing circuits.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

ORDERING INFORMATION(1)

T _A	PACK	AGE ⁽²⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-55°C to 125°C	TSSOP – PW	Reel of 2000	SN74LV4040AMPWREP	LW040A

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.
- (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



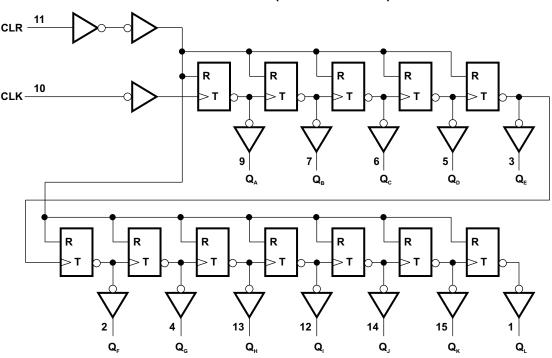
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FUNCTION TABLE (each buffer)

INP	UTS	FUNCTION
CLK	CLR	
1	L	No change
↓	L	Advance to next stage
X	Н	All outputs L

LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range		-0.5	7	V
V_{I}	Input voltage range (2)		-0.5	7	V
Vo	Voltage range applied to any output in the high	n-impedance or power-off state ⁽²⁾	-0.5	7	V
Vo	Output voltage range ⁽²⁾⁽³⁾		-0.5	V _{CC} + 0.5	V
I _{IK}	Input clamp current	V _I < 0		-20	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
Io	Continuous output current	$V_O = 0$ to V_{CC}		±25	mA
	Continuous current through V _{CC} or GND			±50	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾			108	°C/W
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ This value is limited to 5.5 V maximum.

⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



Recommended Operating Conditions⁽¹⁾

			MIN	MAX	UNIT
V _{CC}	Supply voltage		2	5.5	V
		V _{CC} = 2 V	1.5		
V	Lligh lovel input voltage	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$	V _{CC} × 0.7		V
V_{IH}	High-level input voltage	V _{CC} = 3 V to 3.6 V	V _{CC} × 0.7		V
		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$	$V_{CC} \times 0.7$		
		V _{CC} = 2 V		0.5	
V_{IL}	Low-level input voltage	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$		$V_{\text{CC}}\times 0.3$	V
V IL	Low-level input voltage	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		$V_{\text{CC}}\times 0.3$	V
		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$		$V_{\text{CC}}\times 0.3$	
V_{I}	Input voltage		0	5.5	V
V_{O}	Output voltage		0	V _{CC}	V
		V _{CC} = 2 V		-50	
	High level output current	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$		-2	mA
I _{OH}	, ,	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		-6	ША
		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$		-12	
		V _{CC} = 2 V		50	μA
	Low-level output current	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$		2	
l _{OL}	Low-level output current	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		6	mA
		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$		12	
	·	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$		200	
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		100	ns/V
		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$		20	
T _A	Operating free-air temperature		-55	125	°C

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{cc}	MIN	TYP	MAX	UNIT
	$I_{OH} = -50 \mu A$	2 V to 5.5 V	V _{CC} - 0.1			
V	$I_{OH} = -2 \text{ mA}$	2.3 V	2			V
V _{OH}	I _{OH} = -6 mA	3 V	2.48			V
	I _{OH} = -12 mA	4.5 V	3.8			
	I _{OL} = 50 μA	2 V to 5.5 V			0.1	
V	I _{OL} = 2 mA	2.3 V			0.4	V
V _{OL}	I _{OL} = 6 mA	3 V			0.44	V
	I _{OL} = 12 mA	4.5 V			0.55	
I _I	V _I = 5.5 V or GND	0 to 5.5 V			±1	μA
I _{CC}	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			20	μA
I _{off}	V_I or $V_O = 0$ to 5.5 V	0			5	μΑ
C _i	V _I = V _{CC} or GND	3.3 V		1.9		pF

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Timing Requirements

over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

			T _A = 2	5°C	MIN MA		UNIT	
			MIN	MAX			UNIT	
4 Dulas de	Dulas duration	CLK high or low	7		7		20	
ı _w	t _w Pulse duration	CLR high	6.5		6.5		ns	
t _{su}	Setup time	CLR inactive before CLK↓	6.5		6.5		ns	

Timing Requirements

over recommended operating free-air temperature range, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted) (see Figure 1)

			T _A = 2	5°C	MIN MAX		UNIT	
			MIN	MAX			UNII	
4 Dulas duration	Dulas duration	CLK high or low	5		5		20	
ι _w	t _w Pulse duration	CLR high	5		5		ns	
t _{su}	Setup time	CLR inactive before CLK↓	5		5		ns	

Timing Requirements

over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

			T _A = 2	5°C	MIN	MAX	UNIT	
			MIN	MAX	IVIIIN	IVIAA	UNIT	
Delegation (Dulas duration	CLK high or low	5		5		20	
ı _w	t _w Pulse duration	CLR high	5		5		ns	
t _{su}	Setup time	CLR inactive before CLK↓	5		5		ns	

Switching Characteristics

over recommended operating free-air temperature range, $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T _A = 25°C			MIN	MAX	UNIT
FARAIVIETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	IVIIIN	WAA	UNIT
f _{max}			$C_L = 50 pF$	40	95		35		MHz
t _{PLH}	CLK	Q _A	C _L = 50 pF		10.5	24.1	1	28	ns
t _{PHL}	OLK				10.5	24.1	1	28	115
t _{PHL}	CLR	Any Q	$C_L = 50 pF$		11.7	24.5	1	28	ns
Δt_{pd}	Q _n	Q _{n+1}	C _L = 50 pF		1.7	11.1		10.8	ns

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Switching Characteristics

over recommended operating free-air temperature range, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	ТО	LOAD	T _A = 25°C			MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	CE MIN TYP MAX	WAA	ONIT			
f _{max}			C _L = 50 pF	55	130		50		MHz
t _{PLH}	CLK	0	$C_{L} = 50 \text{ pF}$		7.5	15.4	1	17.5	
t _{PHL}	CLK	Q_A	CL = 50 pr		7.5	15.4	1	17.5	ns
t _{PHL}	CLR	Any Q	$C_L = 50 pF$		9	16.3	1	18.5	ns
Δt_{pd}	Q _n	Q _{n+1}	$C_L = 50 pF$		1.2	5.4		6.6	ns

Switching Characteristics

over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T _A = 25°C			MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	IVIIIN	WIAA	UNIT
f _{max}			$C_L = 50 pF$	95	185		80		MHz
t _{PLH}	CLK	Q_A	C _L = 50 pF		5.3	9.3	1	10.5	20
t _{PHL}					5.3	9.3	1	10.5	ns
t _{PHL}	CLR	Any Q	C _L = 50 pF		6.8	10.6	1	12	ns
Δt_{pd}	Q _n	Q _{n+1}	C _L = 50 pF		0.8	4.0		5.5	ns

Noise Characteristics

 $V_{CC} = 3.3 \text{ V}, C_L = 50 \text{ pF}, T_A = 25^{\circ}\text{C}^{-(1)}$

	PARAMETER	MIN	TYP	MAX	UNIT
$V_{OL(P)}$	Quiet output, maximum dynamic V _{OL}		0.5	0.8	V
$V_{OL(V)}$	Quiet output, minimum dynamic V _{OL}		-0.5	-0.8	V
$V_{IH(D)}$	High-level dynamic input voltage	2.31			V
$V_{IL(D)}$	Low-level dynamic input voltage			0.99	V

⁽¹⁾ Characteristics are for surface-mount packages only.

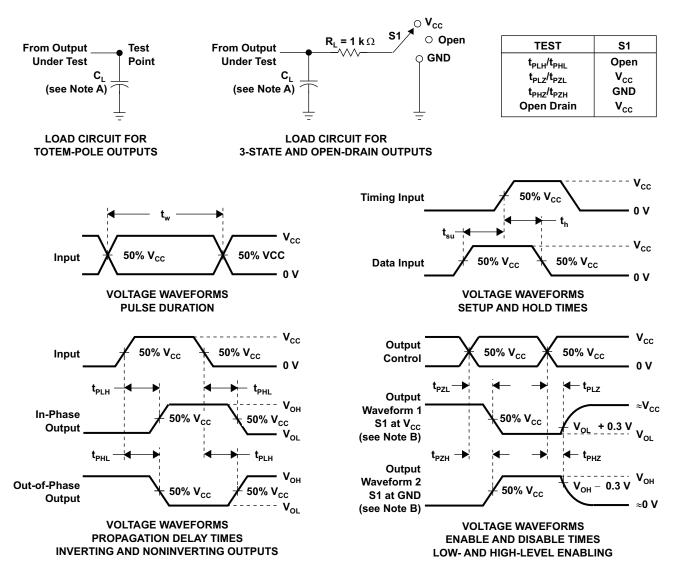
Operating Characteristics

 $T_A = 25^{\circ}C$

	PARAMETER	TEST C	ONDITIONS	V _{CC}	TYP	UNIT
0	Down discinction conscitones	C _L = 50 pF,	f 10 MH=	3.3 V	11.9	pF
C_{pd}	Power dissipation capacitance		f = 10 MHz	5 V	13.1	



PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 Mhz, Z_O = 50 Ω , $t_r \leq$ 3 ns, $t_f \leq$ 3 ns.
 - D. The outputs are measured one at a time, with one input transition per measurement.
 - E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
SN74LV4040AMPWREP	Last Time Buy	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LW040A
V62/07630-01XE	Last Time Buy	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	LW040A

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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• Catalog : SN74LV4040A

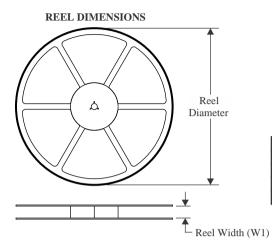
NOTE: Qualified Version Definitions:

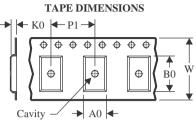
• Catalog - TI's standard catalog product

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	U	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LV4040AMPWREP	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

PACKAGE MATERIALS INFORMATION

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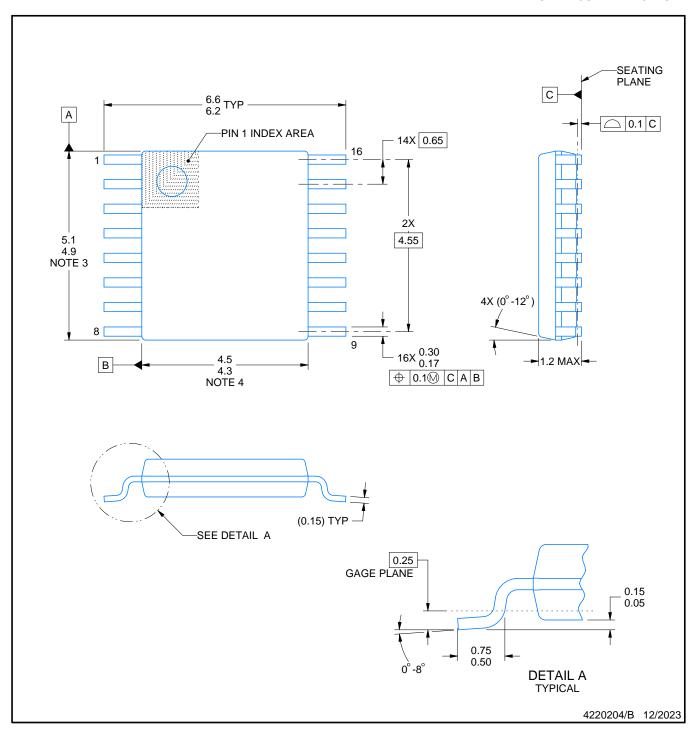


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LV4040AMPWREP	TSSOP	PW	16	2000	353.0	353.0	32.0



SMALL OUTLINE PACKAGE



NOTES:

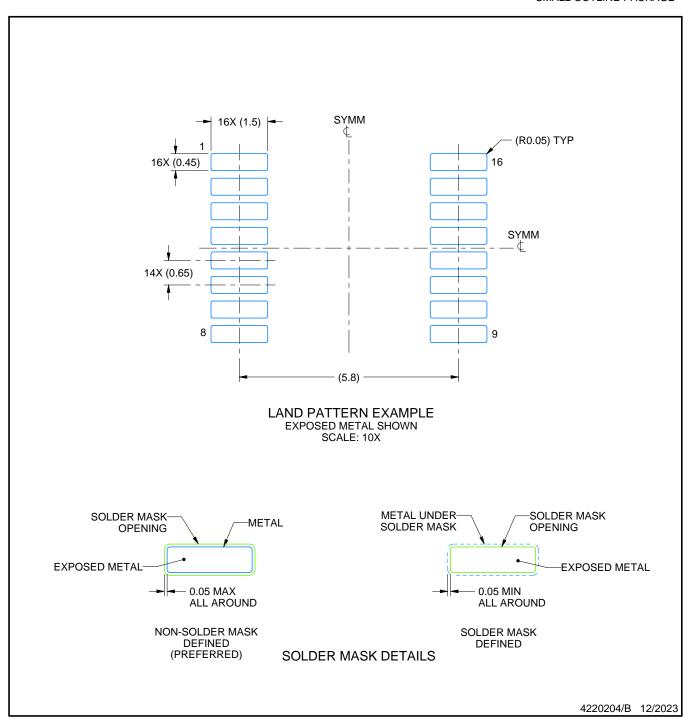
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE

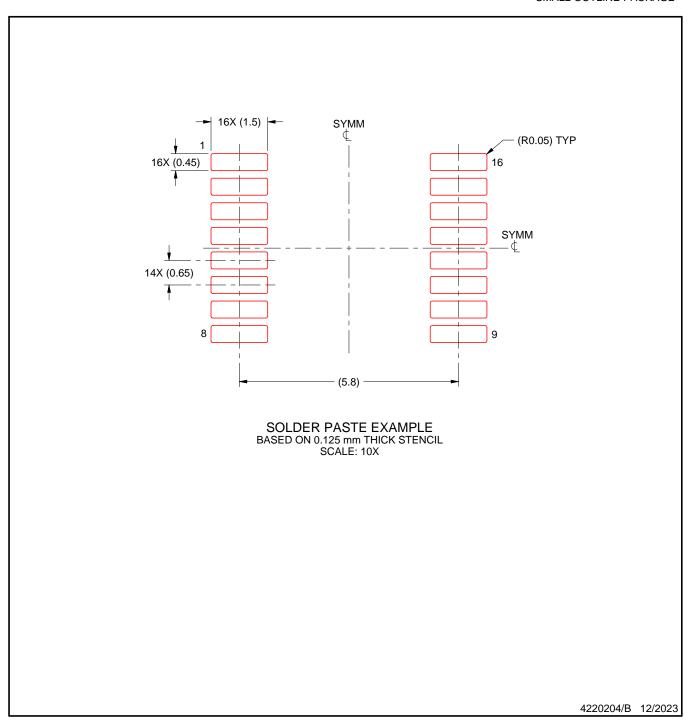


NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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